

Part Number: XZDG45W30MAV-6

3.5 x2.8mm SMD CHIP LED LAMP

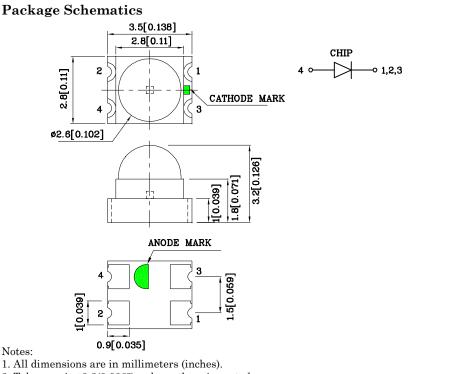
Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package: 500pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		DG (InGaN)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	135	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$. C	
Electrostatic Discharge Threshold (HBM)	450	V		

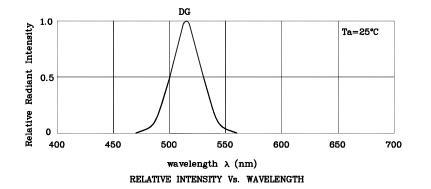
Operating Characteristics (T _A =25°C)		DG (InGaN)	Unit
Forward Voltage (Typ.) (I _F =30mA)	V_{F}	3.5	V
Forward Voltage (Max.) (I _F =30mA)	V_{F}	4.5	V
Reverse Current (Max.) (V _R =5V)	I_R	50	uA
Wavelength of Peak Emission (Typ.) (I _F =30mA)	λP	515	nm
Wavelength of Dominant Emission (Typ.) (I _F =30mA)	λD	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =30mA)	$ riangle\lambda$	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	45	pF

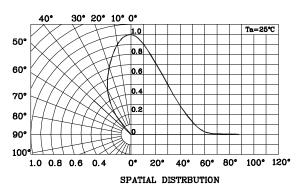
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =30mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZDG45W30MAV-6	Green	InGaN	Water Clear	1500	2090	515	60°

XDSB4693 V2 Layout: Maggie L.

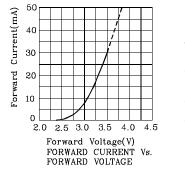


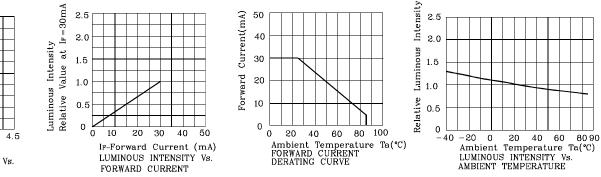
3.5 x2.8mm SMD CHIP LED LAMP

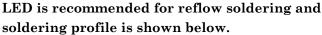


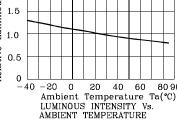


♦ DG

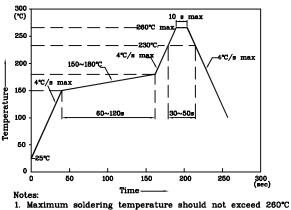








Reflow Soldering Profile for SMD Products (Pb-Free Components)



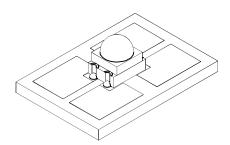
2. Recommended reflow temperature: 145°C-260°C

Do not put stress to the epoxy resin during З.

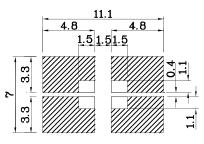
high temperatures conditions



✤ The device has a single mounting surface. The device must be mounted according to the specifications.

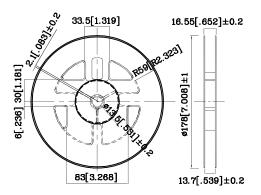


Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

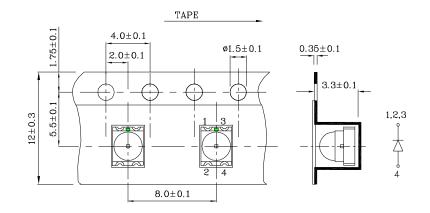


 \boxtimes Solder resist

Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 21,2011



PACKING & LABEL SPECIFICATIONS

